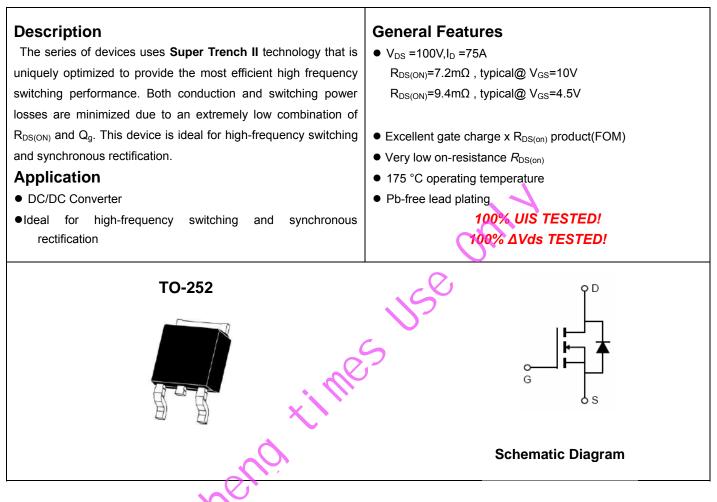


## NCE N-Channel Super Trench II Power MOSFET



### Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCEP078N10AK	NCEP078N10AK	TO-252	-	-	-

### Absolute Maximum Ratings (T<sub>c</sub>=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vds	100	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	I <sub>D</sub>	75	A
Drain Current-Continuous(T <sub>C</sub> =100 ℃)	I <sub>D</sub> (100℃)	58	А
Pulsed Drain Current	I <sub>DM</sub>	300	A
Maximum Power Dissipation	PD	100	W
Derating factor		0.67	W/℃
Single pulse avalanche energy (Note 4)	E <sub>AS</sub>	420	mJ
Operating Junction and Storage Temperature Range	T <sub>J</sub> ,T <sub>STG</sub>	-55 To 175	°C

### **Thermal Characteristic**

Thermal Resistance, Junction-to-Case	R <sub>θJC</sub>	1.5	°C <b>/W</b>	
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# Electrical Characteristics (Tc=25 $^{\circ}$ C unless otherwise noted)

Parameter Syr		Symbol Condition		Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250µA			-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =100V,V <sub>GS</sub> =0V	-	-	1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}$ = $V_{GS}$ , $I_D$ =250 $\mu$ A	1.2	1.7	2.2	V
Drain-Source On-State Resistance	D	$V_{GS}$ =10V, I <sub>D</sub> =37.5A	-	7.2	7.8	mΩ
	R <sub>DS(ON)</sub>	V <sub>GS</sub> =4.5V, I <sub>D</sub> =37.5A	-	9.4	11.5	mΩ
Forward Transconductance	<b>g</b> <sub>FS</sub>	V <sub>DS</sub> =5V,I <sub>D</sub> =37.5A		60	-	S
Dynamic Characteristics (Note3)						
Input Capacitance	C <sub>lss</sub>	V <sub>DS</sub> =50V,V <sub>GS</sub> =0V,	-	3650	-	pF
Output Capacitance	C <sub>oss</sub>	- F=1.0MHz		315	-	pF
Reverse Transfer Capacitance	C <sub>rss</sub>			22	-	pF
Switching Characteristics (Note 3)		150				
Turn-on Delay Time	t <sub>d(on)</sub>	V,	-	16	-	nS
Turn-on Rise Time	tr	V <sub>DD</sub> =50V,I <sub>D</sub> =37.5A		11	-	nS
Turn-Off Delay Time	$t_{d(off)}$	$V_{GS}$ =10V,R <sub>G</sub> =1.6 $\Omega$	-	35	-	nS
Turn-Off Fall Time	t <sub>f</sub>			9	-	nS
Total Gate Charge	Qg	V <sub>DS</sub> =50V,I <sub>D</sub> =37.5A,	-	70	-	nC
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}=50V, I_{D}=37.5A,$ $V_{GS}=10V$	-	14.5	-	nC
Gate-Drain Charge	Q <sub>gd</sub>	V <sub>GS</sub> =10V		16.8	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 2)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =37.5A	-	-	1.2	V
Diode Forward Current	I <sub>S</sub>		-	-	75	А
Reverse Recovery Time	t <sub>rr</sub>	T <sub>J</sub> = 25°C, I <sub>F</sub> = 37.5A	-	60	-	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs <sup>(Note3)</sup>	-	106	-	nC

Notes:

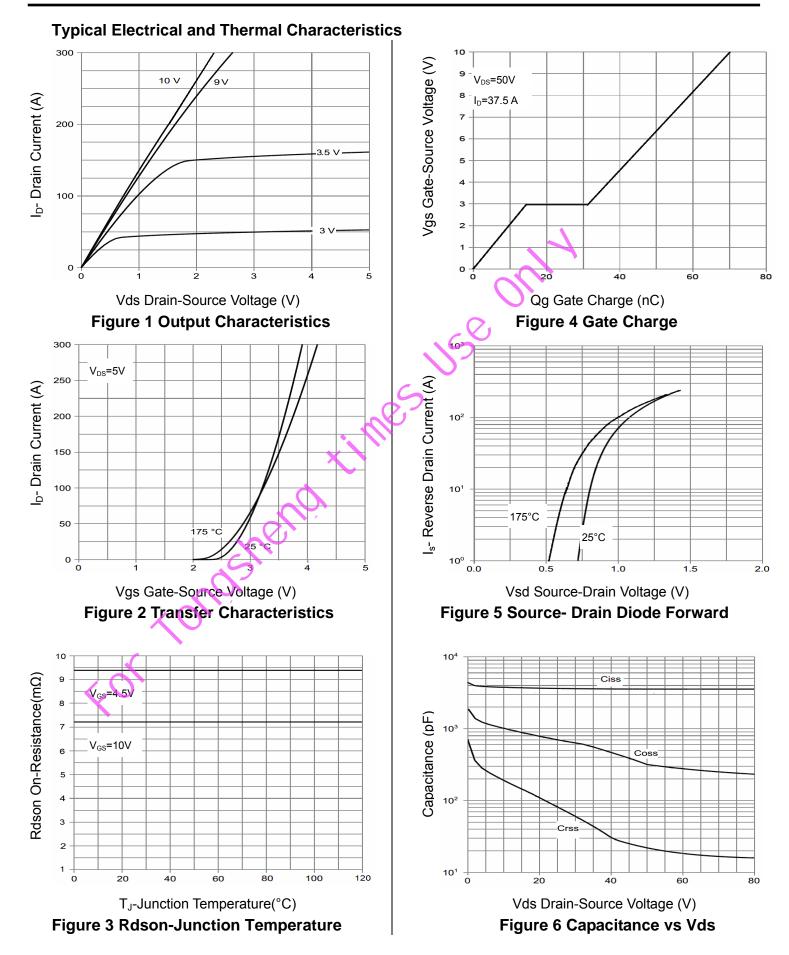
1. Repetitive Rating: Pulse width limited by maximum junction temperature.

2. Pulse Test: Pulse Width  $\leq$  300µs, Duty Cycle  $\leq$  2%.

3. Guaranteed by design, not subject to production

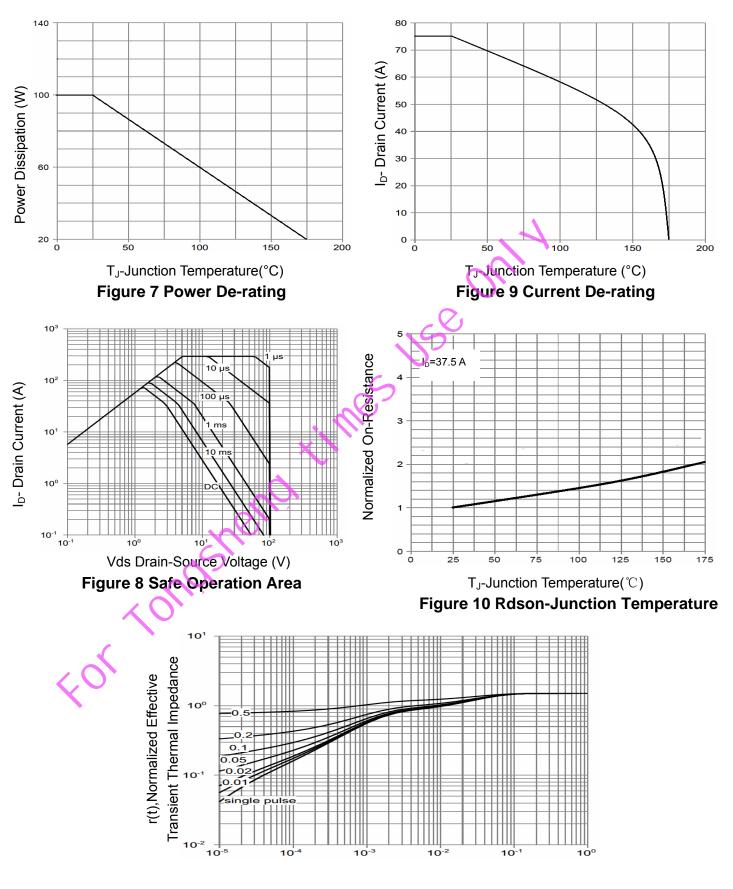
4. EAS condition : Tj=25  $^\circ C$  ,V\_DD=50V,V\_G=10V,L=0.25mH,Rg=25 $\Omega$ 

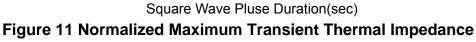






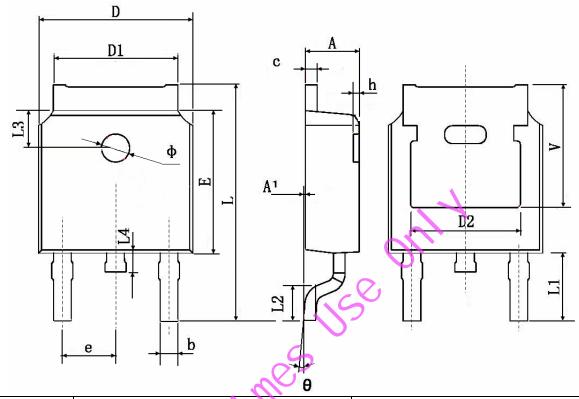
# NCEP078N10AK







### TO-252-2L Package Information



Symbol	Dimensions I	n Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
A	2.200	2.400	0.087	0.094	
A1	0.000	0.127	0.000	0.005	
b	0.660	0.860	0.026	0.034	
С	0.460	0.580	0.018	0.023	
D	6.500	6.700	0.256	0.264	
D1	5.100	5.460	0.201	0.215	
D2	4.83	TYP.	0.190 TYP.		
E	6.000	6.200	0.236	0.244	
e	2.186	2.386	0.086	0.094	
	9.800	10.400	0.386	0.409	
L1	2.900	TYP.	0.114 TYP.		
L2	1.400	1.700	0.055	0.067	
L3	1.600	TYP.	0.063	TYP.	
L4	0.600	1.000	0.024	0.039	
Φ	1.100	1.300	0.043	0.051	
θ	0 °	8°	0°	8°	
h	0.000	0.300	0.000	0.012	
V	5.350	TYP.	0.211	TYP.	



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